

Docket No.: INTEL-021

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Edward A. BURTON, Kumar ANSHUMALI

Serial No: 10/607,550

Filed: 06/27/2003

Confirmation No.: 7414

Group Art Unit: 2818

Examiner: Long K. Tran

Customer No.: 34610

PATENT



For: ADDITION OF METAL LAYERS WITH SIGNAL REALLOCATION TO A MICROPROCESSOR FOR INCREASED FREQUENCY AND LOWER POWER

U.S. Patent and Trademark Office
Customer Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

Dear Sir:

Transmitted herewith is an Amendment and/or Reply in the above identified application.

- ☒ No additional fee is required.
☐ Also attached:

The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	14	30	0	x \$50.00 =	\$ 0.00
Independent Claims	3	3	3	x \$200.00=	\$ 0.00
If multiple claims newly presented, add \$360.00					\$ 0.00
Fee for extension of time					\$ 0.00
TOTAL FEE DUE					\$ 0.00

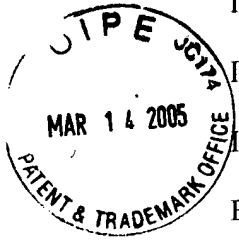
- ☐ Please charge my Deposit Account No. 16-0607 in the amount of \$ _____. An additional copy of this transmittal sheet is submitted herewith.
- ☐ A check in the amount of \$ _____ (Check # _____) is attached.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 16-0607, including any filing fees under 37 C.F.R. 1.16 for presentation of extra claims and any patent application processing fees under 37 C.F.R. 1.17.

Respectfully submitted,
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Date: March 14, 2005

Intel Docket No: P15914 (2112-021)



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of : Assignee: Intel Corporation
)
BURTON, E. et al. : Confirmation No. 7414
)
Serial No. 10/607,550 : Examiner: Tran, L.
)
Filed: June 27, 2003 : Group Art Unit: 2818
)
For: ADDITION OF METAL LAYERS WITH SIGNAL REALLOCATION TO A
MICROPROCESSOR FOR INCREASED FREQUENCY AND LOWER POWER

AMENDMENT

U.S. Patent and Trademark Office
Customer Service Window, Mail Stop Amendment
Randolph Building
401 Dulany Street
Alexandria, Virginia 22314

Sir:

The following amendments and remarks are submitted in response to the Office
Action mailed on January 31, 2005 in connection with the above-identified application.

Amendments to the Claims are in the Listing of Claims beginning on page 2.

Amendments to the Drawings are discussed on page 5.

Remarks begin on page 6.